

Products

Documentation

Resources

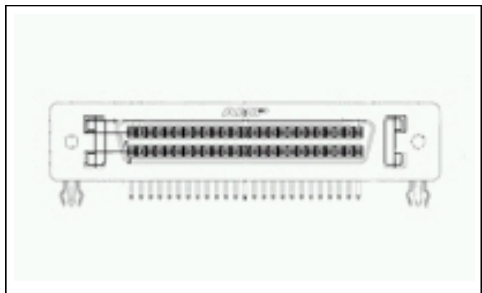
My Account

Customer Support

5787082

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Product Details



5787082

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Active

.050 Series Board Mount Connectors

Always EU RoHS/ELV Compliant

(

Statement of Compliance

)

Product Highlights:

- ? Connector
- ? Receptacle
- ? Number of Positions = 26
- ? Shielded
- ? With Mating Connector Lock

View all Features

|

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Documentation & Additional Information	
Product Drawings: ? RECEPTACLE ASSEMBLY, SHIELDED, RIGHT ANGLE, .050 SER... (PDF, English) Catalog Pages/Data Sheets: ? None Available Product Specifications: ? Connector, AMPLIMITE, Shielded, .050 Series (PDF, English) Application Specifications: ? AMPLIMITE .050 Series Insulation Displacement and Pr... (PDF, English) Instruction Sheets: ? None Available CAD Files: (CAD Format & Compression Information) ? 2D Drawing (DXF, Version O1) ? 3D Model (IGES, Version O1) ? 3D Model (STEP, Version O1) List all Documents	Additional Information: ? Product Line Information Additional Product Images: ? Panel Cutout Related Products: ? Tooling

Product Features (Please use the Product Drawing for all design activity)	
Product Type Features: ? Product Type = Connector ? Gender = Receptacle ? Number of Positions = 26 ? Shielded = Yes ? Mating Connector Lock = With ? Mount Angle = Right Angle ? PCB Polarization = Without ? PCB Retention Feature = Yes ? Rails = Without ? Shell Type = Full Metal ? Product Series = Series III ? Mating Connector Lock Type = Latch Blocks ? Shell Material = Steel ? Bracket Material = Zinc ? PCB Thickness (mm [in]) = 1.57 [0.062] Mechanical Attachment: ? Bracket Plating = Nickel over Copper ? Boardlock Material = Copper Alloy ? Boardlock Plating = Tin over Nickel	Termination Related Features: ? Termination (Solder) Post Length (mm [in]) = 2.84 [0.112] Body Related Features: ? PCB Retention Method = Boardlock(s) ? Post Plating = Tin over Nickel ? Shell Plating = Tin over Copper Contact Related Features: ? Contact Mating Area Plating Material = Gold (30), Gold Flash over Palladium Nickel ? Contact Material = Phosphor Bronze Housing Related Features: ? Housing Material = Thermoplastic ? Housing Flammability Rating = UL 94V -0 Industry Standards: ? RoHS/ELV Compliance = RoHS compliant, ELV compliant ? Lead Free Solder Processes = Reflow solder capable to 245°C, Reflow solder capable to 260°C ? RoHS/ELV Compliance History = Always was RoHS compliant Other: ? Brand = AMP